

MITSUBISHI IGBT MODULES  
**CM100DU-34KA**

HIGH POWER SWITCHING USE

**CM100DU-34KA**



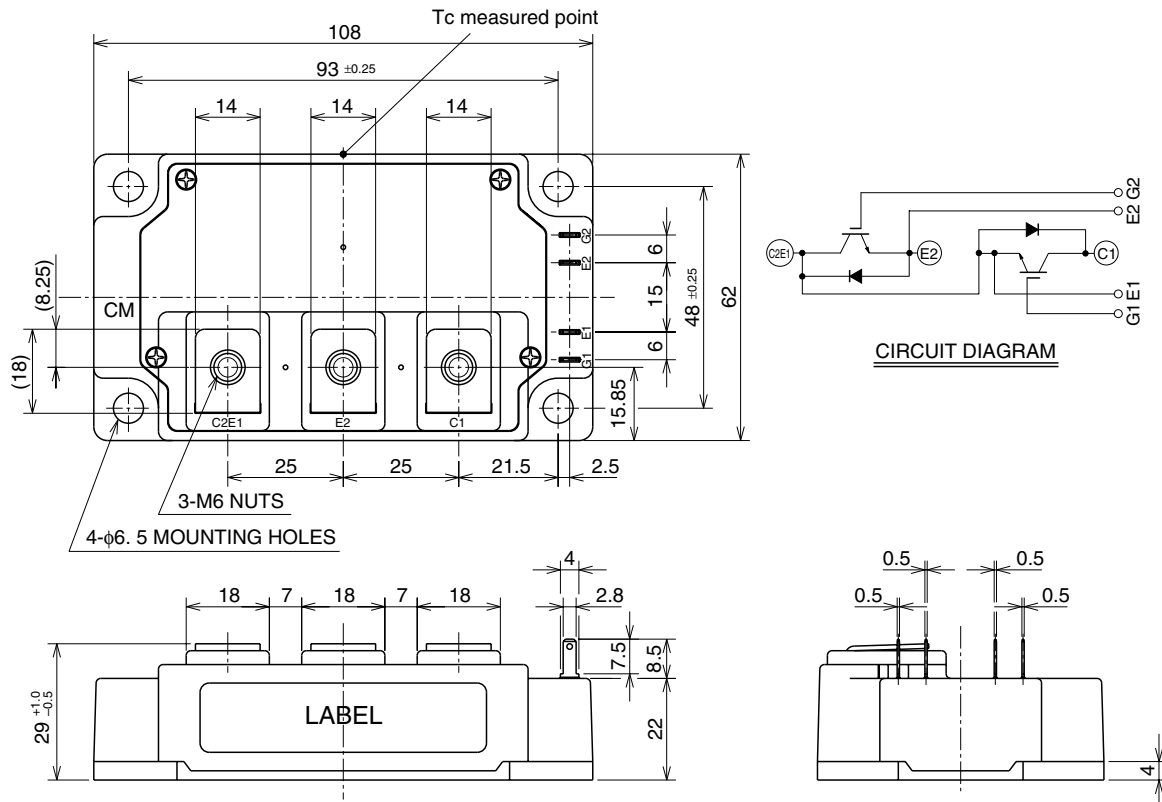
- IC ..... 100A
- VCES ..... 1700V
- Insulated Type
- 2-elements in a pack

**APPLICATION**

General purpose inverters & Servo controls, etc

**OUTLINE DRAWING & CIRCUIT DIAGRAM**

Dimensions in mm



CM100DU-34KA

HIGH POWER SWITCHING USE

MAXIMUM RATINGS (T<sub>j</sub> = 25°C)

| Symbol                   | Parameter                     | Conditions                             | Ratings    | Unit  |
|--------------------------|-------------------------------|--|------------|-------|
| V <sub>CE</sub> S        | Collector-emitter voltage     | G-E Short                              | 1700       | V     |
| V <sub>GE</sub> S        | Gate-emitter voltage          | C-E Short                              | ±20        | V     |
| I <sub>C</sub>           | Collector current             | T <sub>c</sub> = 25°C                  | 100        | A     |
| I <sub>CM</sub>          |                               | Pulse (Note 2)                         | 200        |       |
| I <sub>E</sub> (Note 1)  | Emitter current               | T <sub>c</sub> = 25°C                  | 100        | A     |
| I <sub>EM</sub> (Note 1) |                               | Pulse (Note 2)                         | 200        |       |
| P <sub>C</sub> (Note 3)  | Maximum collector dissipation | T <sub>c</sub> = 25°C                  | 890        | W     |
| T <sub>j</sub>           | Junction temperature          |  | -40 ~ +150 | °C    |
| T <sub>stg</sub>         | Storage temperature           |  | -40 ~ +125 | °C    |
| V <sub>iso</sub>         | Isolation voltage             | Main terminal to base plate, AC 1 min. | 3500       | V     |
| —                        | Torque strength               | Main Terminal M6                       | 3.5 ~ 4.5  | N • m |
|                          |                               | Mounting holes M6                      | 3.5 ~ 4.5  | N • m |
| —                        | Weight                        | Typical value                          | 400        | g     |

ELECTRICAL CHARACTERISTICS (T<sub>j</sub> = 25°C)

| Symbol                   | Parameter                            | Test conditions   | Limits |      |        | Unit |
|--------------------------|--------------------------------------|---|--------|------|--------|------|
|                          |                                      |   | Min.   | Typ. | Max.   |      |
| I <sub>CS</sub>          | Collector cutoff current             | V <sub>CE</sub> = V <sub>CE</sub> S, V <sub>GE</sub> = 0V   | —      | —    | 1      | mA   |
| V <sub>GE(th)</sub>      | Gate-emitter threshold voltage       | I <sub>C</sub> = 10mA, V <sub>CE</sub> = 10V  | 4      | 5.5  | 7      | V    |
| I <sub>GES</sub>         | Gate leakage current                 | V <sub>GE</sub> = V <sub>GES</sub> , V <sub>CE</sub> = 0V   | —      | —    | 0.5    | µA   |
| V <sub>CE(sat)</sub>     | Collector-emitter saturation voltage | T <sub>j</sub> = 25°C   | —      | 3.2  | 4.0    | V    |
|                          |                                      | T <sub>j</sub> = 125°C  | —      | 3.8  | —      |      |
| C <sub>ies</sub>         | Input capacitance                    | V <sub>CE</sub> = 10V<br>V <sub>GE</sub> = 0V   | —      | —    | 14     | nF   |
| C <sub>oes</sub>         | Output capacitance                   |   | —      | —    | 2.4    |      |
| C <sub>res</sub>         | Reverse transfer capacitance         |   | —      | —    | 0.75   |      |
| Q <sub>G</sub>           | Total gate charge                    | V <sub>CC</sub> = 1000V, I <sub>C</sub> = 100A, V <sub>GE</sub> = 15V   | —      | 450  | —      | nC   |
| t <sub>d(on)</sub>       | Turn-on delay time                   | V <sub>CC</sub> = 1000V, I <sub>C</sub> = 100A<br>V <sub>GE1</sub> = V <sub>GE2</sub> = 15V<br>R <sub>G</sub> = 3.1Ω, Inductive load switching operation<br>I <sub>E</sub> = 100A | —      | —    | 350    | ns   |
| t <sub>r</sub>           | Turn-on rise time                    |   | —      | —    | 150    |      |
| t <sub>d(off)</sub>      | Turn-off delay time                  |   | —      | —    | 550    |      |
| t <sub>f</sub>           | Turn-off fall time                   |   | —      | —    | 800    |      |
| t <sub>rr</sub> (Note 1) | Reverse recovery time                |   | —      | —    | 600    |      |
| Q <sub>rr</sub> (Note 1) | Reverse recovery charge              | —   | 5.8    | —    | µC     |      |
| V <sub>EC</sub> (Note 1) | Emitter-collector voltage            | I <sub>E</sub> = 100A, V <sub>GE</sub> = 0V, T <sub>j</sub> = 25°C  | —      | —    | 4.6    | V    |
|                          |                                      | I <sub>E</sub> = 100A, V <sub>GE</sub> = 0V, T <sub>j</sub> = 125°C   | —      | 2.2  | —      | V    |
| R <sub>th(j-c)Q</sub>    | Thermal resistance*1                 | IGBT part (1/2 module)  | —      | —    | 0.14   | °C/W |
| R <sub>th(j-c)R</sub>    |                                      | FWDi part (1/2 module)  | —      | —    | 0.24   |      |
| R <sub>th(c-f)</sub>     | Contact thermal resistance           | Case to fin, Thermal compound applied*2 (1/2 module)  | —      | 0.04 | —      |      |
| R <sub>th(j-c)Q</sub>    | Thermal resistance                   | T <sub>c</sub> measured point is just under the chips   | —      | —    | 0.09*3 |      |

Note 1. I<sub>E</sub>, V<sub>EC</sub>, t<sub>rr</sub>, Q<sub>rr</sub>, die/dt represent characteristics of the anti-parallel, emitter to collector free-wheel diode. (FWDi).

2. Pulse width and repetition rate should be such that the device junction temp. (T<sub>j</sub>) does not exceed T<sub>jmax</sub> rating.

3. Junction temperature (T<sub>j</sub>) should not increase beyond 150°C.

4. Pulse width and repetition rate should be such as to cause negligible temperature rise.

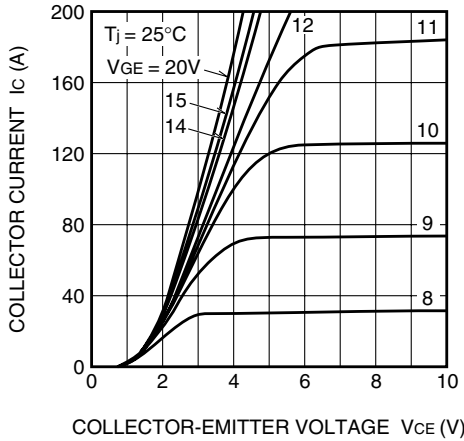
\*1 : T<sub>c</sub> measured point is indicated in OUTLINE DRAWING.

\*2 : Typical value is measured by using Shin-etsu Silicone "G-746".

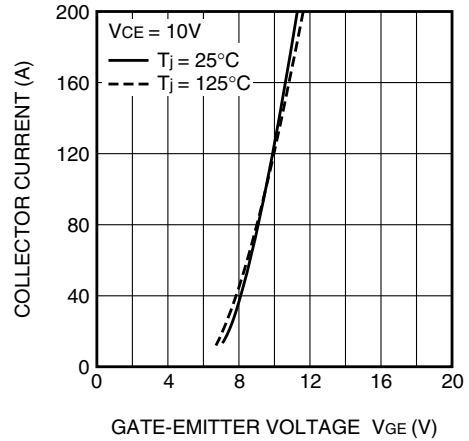
\*3 : If you use this value, R<sub>th(f-a)</sub> should be measured just under the chips.

PERFORMANCE CURVES

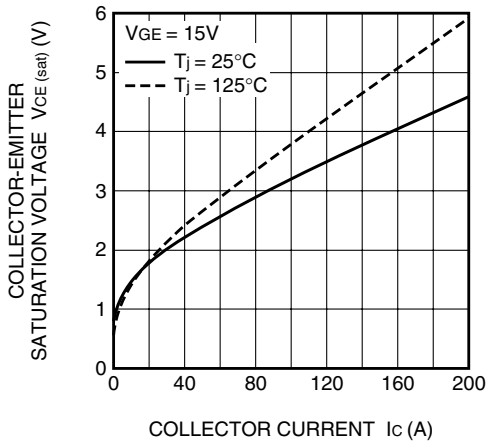
OUTPUT CHARACTERISTICS (TYPICAL)



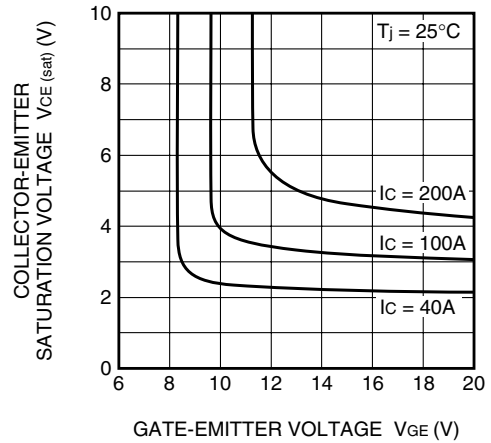
TRANSFER CHARACTERISTICS (TYPICAL)



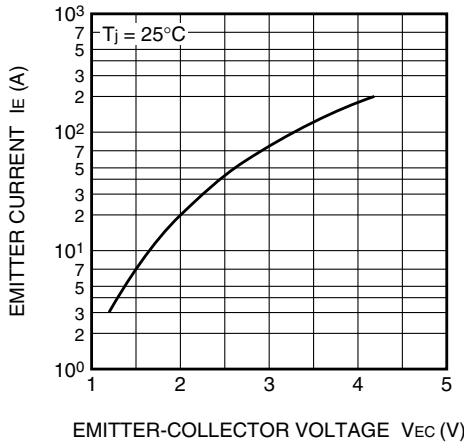
COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



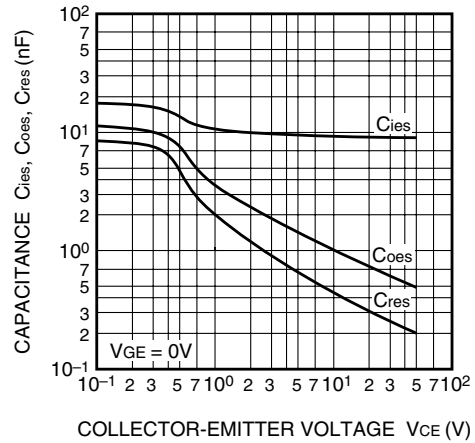
COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



FREE-WHEEL DIODE FORWARD CHARACTERISTICS (TYPICAL)



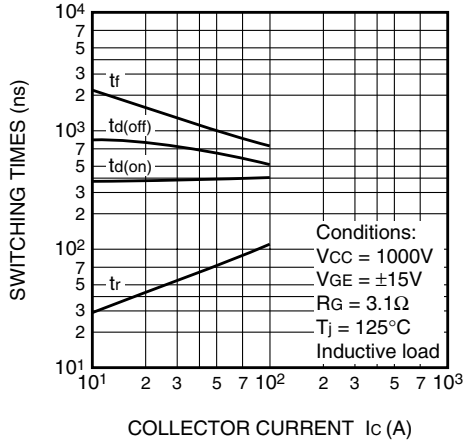
CAPACITANCE-VCE CHARACTERISTICS (TYPICAL)



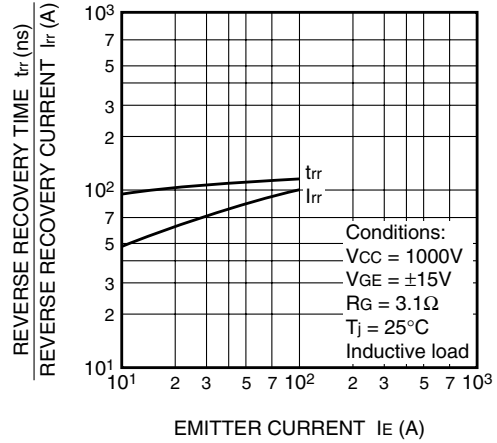
CM100DU-34KA

HIGH POWER SWITCHING USE

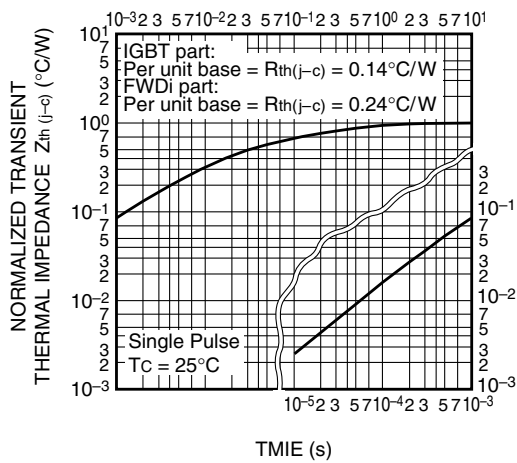
HALF-BRIDGE SWITCHING CHARACTERISTICS (TYPICAL)



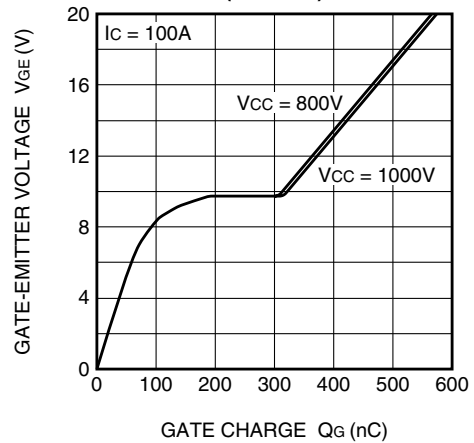
REVERSE RECOVERY CHARACTERISTICS OF FREE-WHEEL DIODE (TYPICAL)



TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS (IGBT part & FWDi part)



GATE CHARGE CHARACTERISTICS (TYPICAL)





LittleDiode supplies new, hard to find or obsolete electronic components and semiconductors all over the world.

With over two million different components listed you are sure to find the part you need.

Feel free to visit us today at our online store:

[LittleDiode.com](http://LittleDiode.com)

Looking forward to providing you with the best possible service.